

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V_{DSS}	30	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 5)	Steady State	$T_A = +25^{\circ}C$ $T_A = +85^{\circ}C$	I _D	9.7 6.3	А
Pulsed Drain Current (Note 6)			I _{DM}	48	Α

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_{D}	1.68	W
Thermal Resistance, Junction to Ambient @T _A = +25°C	R∙JA	74.3	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Notes:

- 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.
- 6. Repetitive rating, pulse width limited by junction temperature.

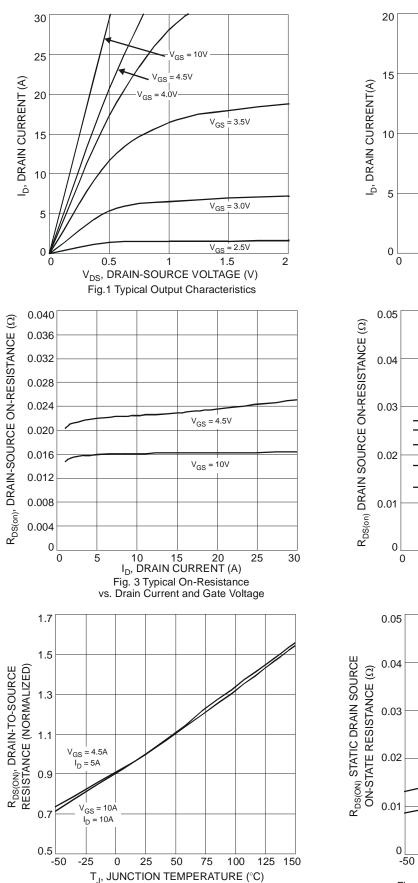
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

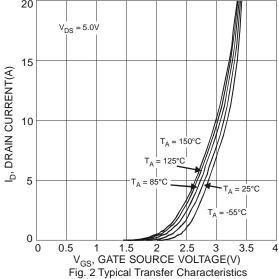
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	30	-	-	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	-	-	1.0	μA	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	-	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(th)}	1.05	-	1.95	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance		-	11	16	mΩ	$V_{GS} = 10V, I_D = 11.6A$	
Static Drain-Source On-Resistance	R _{DS} (ON)		17	25		$V_{GS} = 4.5V, I_D = 10A$	
Forward Transfer Admittance	Y _{fs}	-	8	-	S	$V_{DS} = 10V, I_{D} = 9A$	
Diode Forward Voltage	V_{SD}	-	0.73	1.0	V	$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 8)	0 00 70						
Input Capacitance	C _{iss}	ı	867	-	pF	V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	Coss	-	85	-	pF		
Reverse Transfer Capacitance	C _{rss}	-	81	-	pF		
Gate Resistance	R_g	-	1.39	-	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	-	18.85	-	nC	$V_{GS} = 10V, V_{DS} = 15V,$ $I_D = 11.6A$	
Gate-Source Charge	Q_{gs}	-	2.59	-	nC		
Gate-Drain Charge	Q_{gd}	-	6.15	-	nC		
Turn-On Delay Time	t _{D(on)}	-	5.46	-	ns	$V_{DD} = 15V, V_{GS} = 10V,$ $R_{L} = 1.3\Omega, R_{G} = 3\Omega$	
Turn-On Rise Time	t _r	-	14.53	-	ns		
Turn-Off Delay Time	t _{D(off)}	-	18.84	-	ns		
Turn-Off Fall Time	t _f	-	6.01	-	ns		

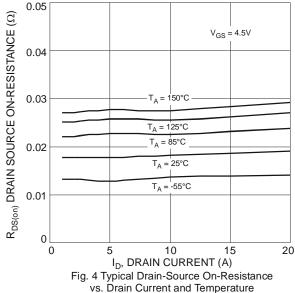
Notes:

- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to production testing.









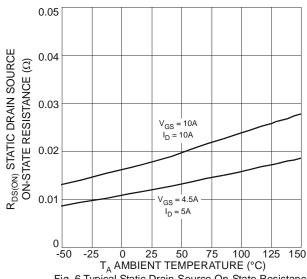
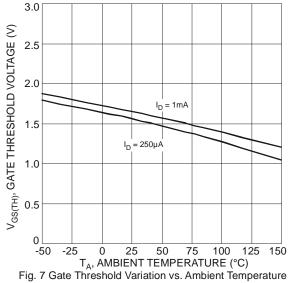
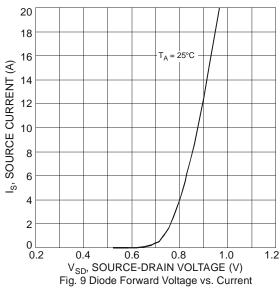


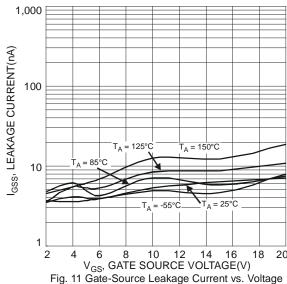
Fig. 6 Typical Static Drain-Source On-State Resistance vs. Ambient Temperature

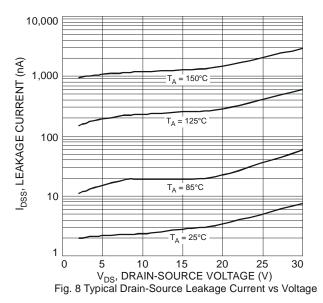
Fig. 5 On-Resistance Variation with Temperature

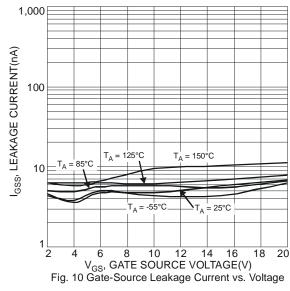












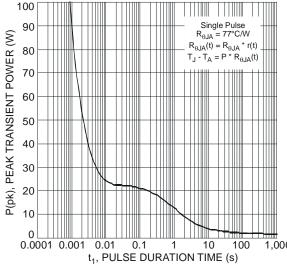
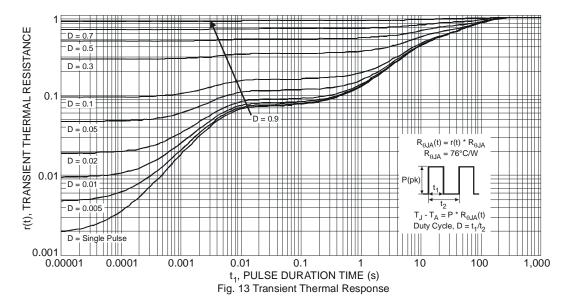


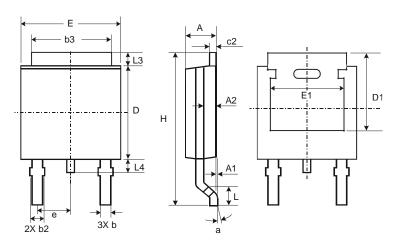
Fig. 12 Single Pulse Maximum Power Dissipation





Package Outline Dimensions

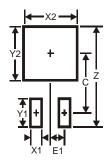
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



TO252					
Dim	Min	Max	Тур		
Α	2.19	2.39	2.29		
A 1	0.00	0.13	0.08		
A2	0.97	1.17	1.07		
q	0.64	0.88	0.783		
b2	0.76	1.14	0.95		
b3	5.21	5.46	5.33		
c2	0.45	0.58	0.531		
D	6.00	6.20	6.10		
D1	5.21	_	_		
е	_	_	2.286		
Е	6.45	6.70	6.58		
E1	4.32	_	-		
Н	9.40	10.41	9.91		
L	1.40	1.78	1.59		
L3	0.88	1.27	1.08		
L4	0.64	1.02	0.83		
а	0°	10°	_		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	11.6
X1	1.5
X2	7.0
Y1	2.5
Y2	7.0
С	6.9
E1	2.3



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